

TQEMN1525V0

Ultra-low Capacitance Bidirectional Micro Packaged TVS Diodes for ESD Protection

Description

The TQEMN1525V0 is designed with TVSII Punch-Through process TVS technology to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space comes at a premium. Also because of its low capacitance, it is suited for use in high frequency designs such as USB 2.0 high speed, USB 3.0 super speed, VGA, DVI, HDMI, ESATA and other high speed line applications.

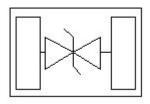
Feature

- > 20W peak pulse power (tP = 8/20μs)
- DFN1006 Package
- Working voltage: 5V
- Low clamping voltage
- Low capacitance
- RoHS compliant transient protection for high speed data

lines to

IEC61000-4-2(ESD)±20kV(air),±20kV(contact)

PIN configuration



DFN1006-2L

Applications

- > DVI & HDMI Port Protection
- Serial and Parallel Ports
- Projection TV
- > Notebooks, Desktops, Servers
- Solid-state Punch-Through TVS Process technologyPortable instrumentation

Machanical data

- ➤ Lead finish:100% matte Sn(Tin)
- Mounting position: Any
- Qualified max reflow temperature:260°C
- Device meets MSL 1 requirements
- ➤ Pure tin plating: 7 ~ 17 um
- ➤ Pin flatness:≤3mil

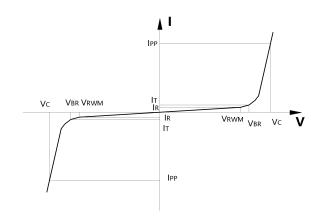
Ordering Information

Device	Package	Marking	Qty per Reel	Reel Size
TQEMN1525V0	DFN1006	56	10000	7 Inch



• Electronic Parameter

Symbol	Parameter	
V_{RWM}	Peak Reverse Working Voltage	
I_R	Reverse Leakage Current @ V _{RWM}	
V_{BR}	Breakdown Voltage @ I _T	
I _T	Test Current	
I _{PP}	Maximum Reverse Peak Pulse Current	
V _C	Clamping Voltage @ IPP	
P _{PP}	Peak Pulse Power	
С	Junction Capacitance	



Absolute maximum rating @TA=25°C

Symbol	Parameter	Value	Units	
P _{PP}	Peak Pulse Power(8/20µS)	20	W	
T _{STG}	Storage Temperature	-55/+150	°C	
TJ	Operating Temperature	-55/+150	°C	

• Electrical Characteristics @TA=25°C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Peak Reverse Working	V_{RWM}			5		V
Voltage						
Breakdown Voltage	V_{BR}	It = 1mA		7		V
Reverse Leakage Current	I _R	VRWM =5.0V, T=25°C			1	μA
Clamping Voltage	Vc	IPP = 2A, tP = 8/20μs		10		V
Junction Capacitance	C₃	VR=0V, f = 1MHz		1.9		pF



• Typical Performance Characteristics

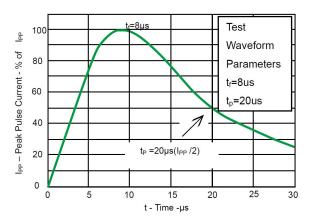


Fig 1.Pulse Waveform

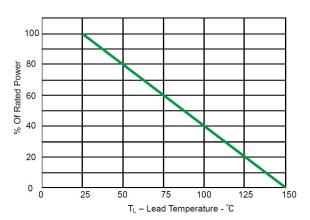
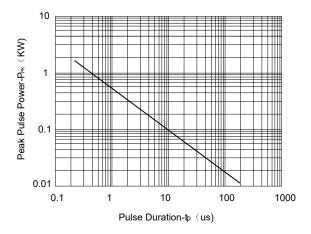
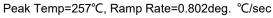


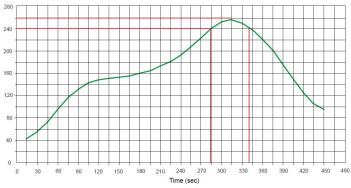
Fig 2.Power Derating Curve



Non-Repetitive Peak Pulse Power vs. Pulse Time

Solder Reflow Recommendation





3/4

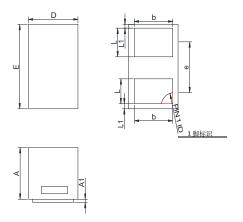


Package Information

Mechanical Data

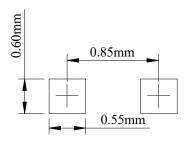
Case:DFN1006

Case Material: Molded Plastic. UL Flammability



DIM	Millimeters			
	Min	Max		
Α	0.30	0.50		
A1	0.00 0.05			
D	0.55	0.65		
E	0.95	1.05		
b	0.25	0.60		
е	0.65TYP			
L	0.15	0.35		
L1	0.05REF			

Recommended Pad outline



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